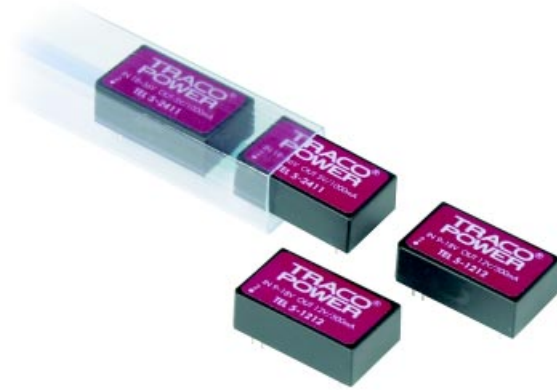


Features

- Wide 2:1 Input Range
- Cost efficient SMD-Design
- High Power Density
- High Efficiency up to 86%
- Regulated Outputs
- I/O-Isolation 1'500 VDC
- Indefinite Short-Circuit Protection
- 24-pin DIP with Industry Standard Pinout
- High Reliability, MTBF >1 Mio. h
- Internal EMI Filter to comply with EN 55022, Class A (optional)
- 3 Year Product Warranty



The TEL 5 Series is a range of DC/DC-converter modules with wide input range of 2:1. State of the art SMD-technology guarantees a product with very high reliability and excellent cost /performance ratio. High efficiency allows an operating temperature range of -40°C to $+71^{\circ}\text{C}$ without derating. This product series provides an economical solution for many cost critical applications in industrial and consumer electronics.

Models

Ordercode	Input voltage range	Output voltage	Output current max.	Efficiency typ.
TEL 5-1210	9 – 18 VDC	3.3 VDC	1200 mA	77 %
TEL 5-1211		5 VDC	1000 mA	81 %
TEL 5-1212		12 VDC	500 mA	84 %
TEL 5-1222		± 12 VDC	± 250 mA	84 %
TEL 5-1223		± 15 VDC	± 200 mA	84 %
TEL 5-2410	18 – 36 VDC	3.3 VDC	1200 mA	79 %
TEL 5-2411		5 VDC	1000 mA	83 %
TEL 5-2412		12 VDC	500 mA	86 %
TEL 5-2422		± 12 VDC	± 250 mA	86 %
TEL 5-2423		± 15 VDC	± 200 mA	86 %

Input Specifications

Input current no load /full load	12 Vin models:	20 mA / 590 mA typ.
	24 Vin models:	5 mA / 290 mA typ.
Start-up voltage / under voltage shut down	12 Vin models:	8.0 VDC / 8.0 VDC
	24 Vin models:	16.0 VDC / 16.0 VDC
Surge voltage (1 sec. max.)	12 Vin models:	25 V max.
	24 Vin models:	50 V max.
Reverse voltage protection		1.0 A max.

Output Specifications

Voltage set accuracy		± 1 %
Regulation	– Input variation Vin min. to Vin max.	± 0.3 % max.
	– Load variation 20 – 100 %	
	– single output models	± 1 % max
	– dual output models balanced load	± 2 % max.
Ripple and noise (20 MHz Bandwidth)		75 mVpk-pk max.
Temperature coefficient		± 0.02 % /K
Output current limitation		>120 % of Iout max., constant current
Short circuit protection		indefinite (automatic recovery)
Capacitive load	single output models:	6800 µF max.
	dual output models:	1000 µF max. (each output)

General Specifications

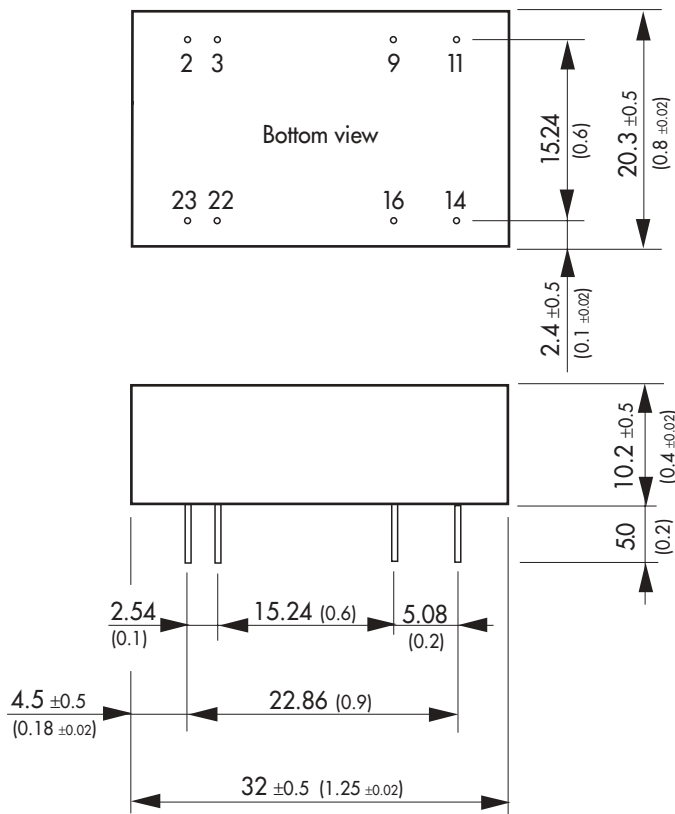
Temperature ranges	– Operating	– 40 °C ... + 71 °C (no derating)
	– Case temperature	+ 90 °C
	– Storage	– 40 °C ... + 125 °C
Humidity (non condensing)		95 % rel H max.
Reliability, calculated MTBF (MIL-HDBK-217 E)		> 1 Mio. h @ + 25 °C
Isolation voltage	Input/Output	1'500 VDC
Isolation capacity	Input/Output	380 pF typ.
Isolation resistance	Input/Output (500 VDC)	> 1'000 M Ohm
Switching frequency		300 kHz typ.
Safety standards		IEC 60950, EN 60950

All specifications valid at nominal input voltage, full load and +25°C after warm-up time unless otherwise stated.

Physical Specifications

Case material	non conductive plastic (UL 94V-0 rated)
Weight	17 g (0.60 oz)
Soldering temperature	max. 260 °C / 10 sec.

Outline Dimensions mm (inches)



Pin-Out		
Pin	Single	Dual
2	-Vin (GND)	-Vin (GND)
3	-Vin (GND)	-Vin (GND)
9	No pin	Common
11	No con.	-Vout
14	+Vout	+Vout
16	-Vout	Common
22	+Vin (Vcc)	+Vin (Vcc)
23	+Vin (Vcc)	+Vin (Vcc)

Pin diameter $\varnothing 0.5 \pm 0.05$ (0.02 ±0.002)
Tolerances ± 0.5 (0.02)

Specifications can be changed without notice